TOSHIBA Photocoupler IRED & Photo-MOS FET

# **TLP197G**

Modem

Fax

**PBX** 

#### Measurement Instrumentation

The TOSHIBA mini flat photo relay TLP197G is a small outline photo relay, suitable for surface mount assembly.

The TLP197G consists of an infrared emitting diode optically coupled to a photo—MOS FET in a six lead 2.1mm height package, which enable TLP197G to be applied in card modems.

The TLP197G is a bi—directional switch which can replace mechanical relays in fax machines and modems etc.

SOP 6pin(2.54SOP6): 1-form-A
 Peak off-state voltage: 350 V (min)
 Trigger LED current: 3 mA (max)

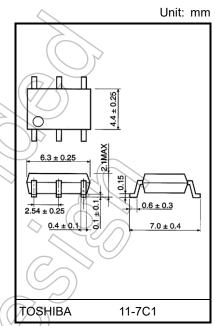
• On-state current: 120 mA (max) (A connection)

On-state resistance: 35 Ω (max)
 Isolation voltage: 1500 Vrms (min)

• UL-recognized: UL 1577, File No.E67349

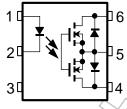
• cUL-recognized: CSA Component Acceptance Service No.5A

File No.E67349



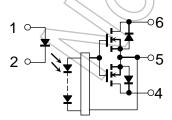
Weight: 0.13g (typ.)

### Pin Configuration (top view)



- 1 : Anode
- 2 : Cathode
- 3 : NC
- 4 : Drain D1
- 5 : Source
- 6 : Drain D2

#### **Schematic**



Start of commercial production 1996-03

#### Absolute Maximum Ratings (Ta = 25°C)

	Characteristics		Symbol	Rating	Unit
Ped	Forward current	lF	50	mA	
	Forward current derating (Ta ≥ 25°C)	ΔI <sub>F</sub> /°C	-0.5	mA/°C	
	Pulse forward current (100µs pulse,100	IFP	1	Α	
	Reverse voltage	VR	5	V	
_	Diode power dissipation		PD	50	mW
	Diode power dissipation derating (Ta >	25°C)	ΔP <sub>D</sub> /°C	-0.5	mW/°C
	Junction temperature	Tj	125	°C	
	Off-state output terminal voltage	Voff	350	(VX)	
		A connection			
	On-state current	B connection	Ion	120	mΑ
		C connection			
		A connection		7	
	On-state current derating (Ta ≥ 25°C)	B connection	ΔI <sub>ON</sub> /°C	-1.2	mA/°C
ctor		C connection		7/^	
Detector		A connection		()	$\Diamond$
	Output power dissipation	B connection	Po	300	mW
		C connection		<b>&gt;</b>	
	Output a sure a discipation describes	A connection			
	Output power dissipation derating (Ta ≥ 25°C)	B connection	ΔPo/°C	-3.0	mW /°C
	(14 = 25 0)	C connection			()
	Junction temperature	40		125	°C
Storage temperature range			T <sub>stg</sub>	-55 to 125	°C
Operating temperature range			T <sub>opr</sub>	-40 to 85	ů
Lead	Lead soldering temperature(10 s)			260	°C
Isola	ation voltage (AC, 60 s, R.H. ≤ 60 %)	(Note 1)	BVs	1500	Vrms

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

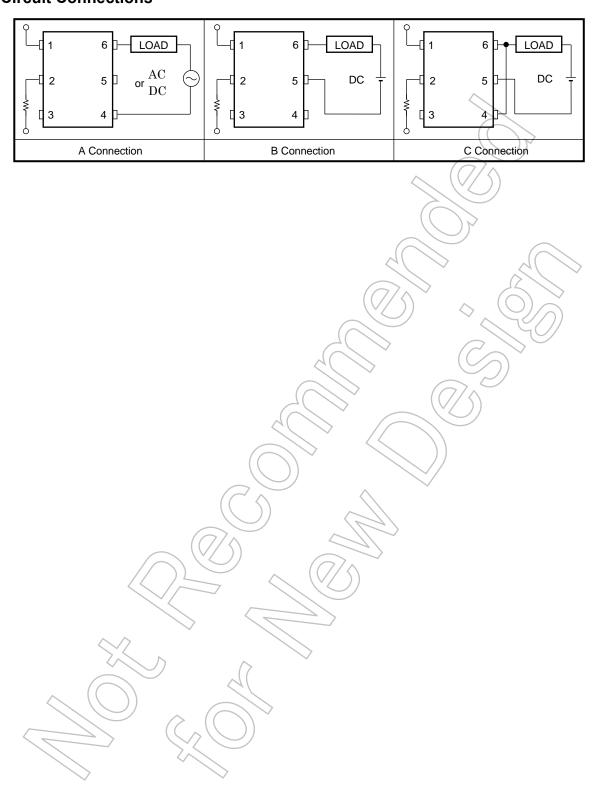
Note 1: Device considered a two-terminal device: Pins1, 2 and 3 shorted together and pins 4, 5 and 6 shorted together.

## **Recommended Operating Conditions**

Characteristic	Symbol	Min	Тур.	Max	Unit
Supply voltage	Vcc	_	_	280	V
Forward current	lF	5	7.5	25	mA
On-state current(A connection)	Ion	_	_	100	mA
Operating temperature	T <sub>opr</sub>	-20	_	65	°C

Note: Recommended operating conditions are given as a design guideline to obtain expected performance of the device. Additionally, each item is an independent guideline respectively. In developing designs using this product, please confirm specified characteristics shown in this document.

## **Circuit Connections**



## **Individual Electrical Characteristics (Ta = 25°C)**

	Characteristic	Symbol	Test Condition	Min	Тур.	Max	Unit
	Forward voltage	VF	I <sub>F</sub> =1 0 mA	1.0	1.15	1.3	V
Peq	Reverse current	I <sub>R</sub>	V <sub>R</sub> = 5 V	_	_	10	μΑ
	Capacitance	Ст	VF = 0 V, f = 1 MHz	/	30		pF
Detector	Off-state current	loff	Voff = 350 V		$\rightarrow$	1	μА
	Capacitance	Coff	V = 0 V, f = 1 MHz		40		pF

## **Coupled Electrical Characteristics (Ta = 25°C)**

Characteristic		Symbol	Test Condition	Min	Тур.	Max	Unit
Trigger LED current		I <sub>FT</sub>	I <sub>ON</sub> = 120 mA	1	1	3	mA
0	A		I <sub>ON</sub> = 120 mA, I <sub>F</sub> = 5 mA	7	22	35	
On-state resistance	A connection	RON	ION = 20 to 120 mA, IF = 5 mA		26/	40	Ω

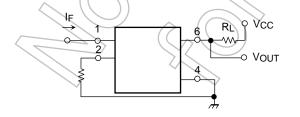
## Isolation Characteristics (Ta = 25°C)

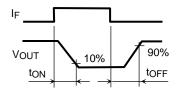
Characteristic	Symbol	Test Condition	Min	Тур.	Max	Unit
Capacitance input to output	Cs	Vs = 0 V, f = 1 MHz	_	8.0	_	pF
Isolation resistance	Rs	V <sub>S</sub> = 500 V, R.H. ≤ 60 %	5×10 <sup>10</sup>	10 <sup>14</sup>	_	Ω
Isolation voltage	BVs	AC, 60 s	1500	_	_	V <sub>rms</sub>

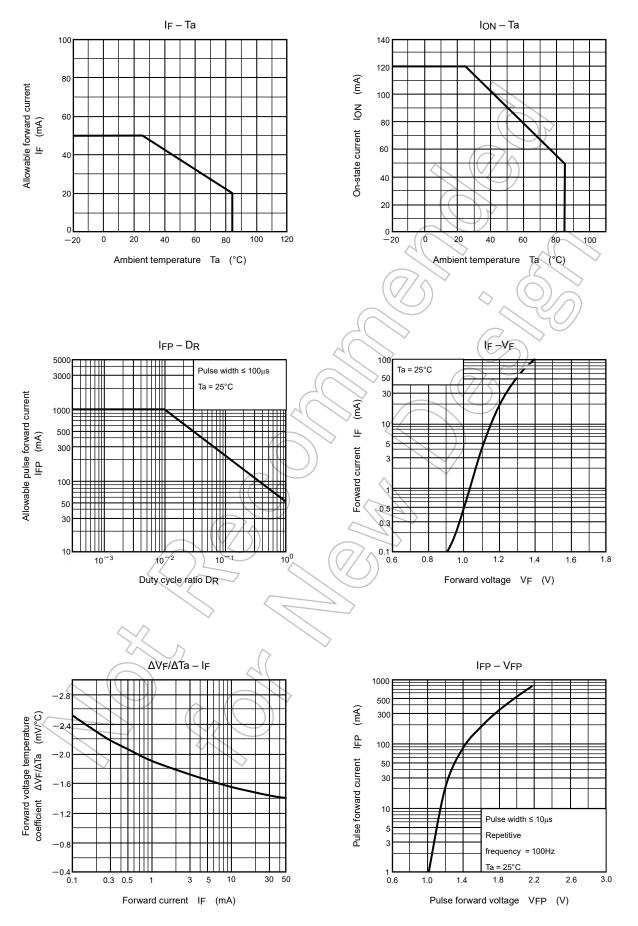
# Switching Characteristics (Ta = 25°C)

Characteristic	Symbol	Test Condition		Min	Тур.	Max	Unit
Turn-on time	ton	$R_L = 200 \Omega$	(Note 2)	_	0.3	1	<b></b>
Turn-off time	toff	$VCC \Rightarrow 20 \text{ V, IF} = 5 \text{ mA}$		_	0.1	1	ms

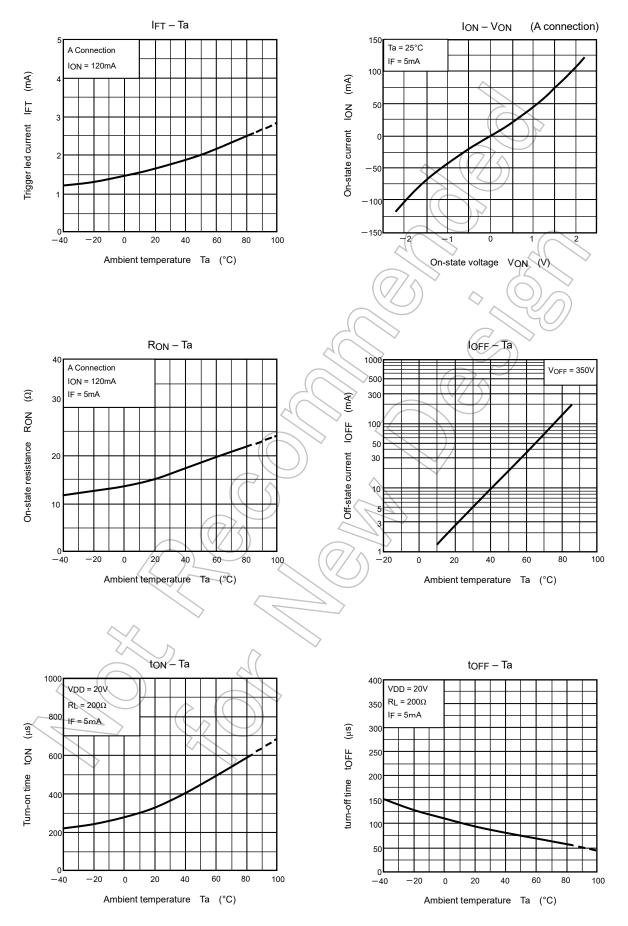
#### Note2: Switching time test circuit







NOTE: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.



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